

This optical transceiver is capable of free-space optical data communication. By placing two of this product facing each other on the optical axis, full-duplex two-way communication with a transmission distance of up to 100 mm is realized. Maximum data rate is 1.25 Gbps, and this characteristic is maintained even when communicating between a 360° rotating object and stationary object. This product also has a built-in transmitter and receiver. For the transmitter we use a 850 nm VCSEL, and by combining it with a driver IC that can compensate for temperature, it is possible to do stable communication over a wide operating temperature range. The receiver consists of a PIN photodiode and a signal processing IC, and is capable of high-speed operation.

#### Features

- Data rate: 100 Mbps to 1.25 Gbps
- Transmission distance: 25 mm to 100 mm
- Full duplex two-way communication
- Supports 360° degree rotation mechanism
- CML interface
- 850 nm VCSEL (laser class 1)

#### - Applications

Short-distance board-to-board communication

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Communication via rotation mechanism

Parameter	Symbol	Value	
Supply voltage	Vcc	-0.4 to +3.6	V
Input voltage	Vin	-0.85 to +1.85	V
Operating temperature	Topr	-40 to +85	°C
Storage temperature	Tstg	-40 to +105	°C
Soldering temperature*1	Tsol	260 (twice)	°C

# Absolute maximum ratings

\*1: Reflow soldering, IPC/JEDEC J-STD-020 MSL3, see P.5

Note: Exceeding the absolute maximum ratings even momentarily may cause a drop in product quality. Always be sure to use the product within the absolute maximum ratings.

### Recommended operating conditions

Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit	
Supply voltage	Vcc		3.135	3.3	3.465	V	
Data rate	DR	PRBS 2 <sup>7</sup> - 1, NRZ	100	-	1250	Mbps	
Transmission distance*2	d1	DR: 100 to 625 Mbps	25	-	100	mm	
	d2	DR: 625 Mbps to 1.25 Gbps	25	-	50		
Receiver output load	RL	Differential	-	100	-	Ω	

\*2: Distance between the bottom faces of the optical transceivers when using optical transceivers facing each other

## Electrical and optical characteristics (Ta=-40 to +85 °C, Vcc=3.135 to 3.465 V, unless otherwise noted)

Transmitter

Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
Current consumption	Icc	*3	-	15	25	mA
Differential input voltage*4	Vid	AC coupling, peak to peak	400	-	1600	mV
Input differential impedance	Rin	AC coupling	-	100	-	Ω
Center emission wavelength	ι λς		-	850	-	nm
*3: Input signal						
Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
Input rise time	tr	20 to 80%, 1.25 Gbps	30	-	80	ps
Input fall time	tf	80 to 20%, 1.25 Gbps	30	-	80	ps
Total jitter	Tj	1.25 Gbps	-	-	0.15	UI

\*4: Light output becomes indefinite below 400 mV

Note: Connect at least one bypass capacitor (0.1  $\mu$ F) within 3 mm of the terminals (between Vcc\_Tx and GND). Also, connect other capacitors nearby.

Receiver

Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
Current consumption	Icc		-	60	75	mA
Differential output voltage	Vod	AC coupling, differential load=100 Ω	400	-	700	mV
Output rise time	tr	20 to 80%	-	200	-	ps
Output fall time	tf	80 to 20%	-	200	-	ps
Output eye opening width	Teyerx	When there is electrical signal input without jitter	0.5	-	-	UI
Signal detection time*5	Tsd_on		-	-	100	μs

\*5: Time from optical signal input to stable output operation

Note: Connect at least one bypass capacitor (0.1  $\mu\text{F})$  within 3 mm of the terminals (between Vcc\_Rx and GND).

Also, connect other capacitors nearby.



## Dimensional outline (unit: mm)



# Recommended land pattern (unit: mm)



Tolerance unless otherwise noted:  $\pm 0.1$ 

KPICC0393EA

KPICA0120EA

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## Reel packing specifications

Reel (conforms to JEITA ET-7200)

Dimensions	Hub diameter	Tape width	Material	Electrostatic characteristics
ф330 mm	φ100 mm	16 mm	PS	Conductive

Embossed tape (unit: mm, material: PS, conductive)







KPICC0396EA

- Packing quantity 500 pcs/reel
- Packing state

Reel and desiccant in moisture-proof packaging (vacuum-sealed)



## Application circuit example



## Recommended reflow soldering conditions



Time

KSPDB0419EA

- · Do not use a vapor phase reflow oven, because moisture may get inside the package through the air holes in the bottom of the package.
- $\cdot$  Do not ultrasonic cleaning, steam cleaning, or soak washing.
- This product supports lead-free soldering. After unpacking, store it in an environment at a temperature of 30 °C or less and a humidity of 60% or less, and perform soldering within 168 hours.
- The effect that the product receives during reflow soldering varies depending on the circuit board and reflow oven that are used. When you set reflow soldering conditions, check that problems do not occur in the product by testing out the conditions in advance.



## Evaluation kit M17545-01 for optical transceiver

We offer an evaluation kit for the optical transceiver P16548-01AT. Contact us for detailed information.

## Structure

- · Evaluation board with optical transceiver P16548-01AT (×2)
- Power cable



## Equivalent circuit



KPICC0395EA



## Related information

www.hamamatsu.com/sp/ssd/doc\_en.html

- Precautions
- Disclaimer
- · Precautions / Metal, ceramic, plastic package products
- Precautions / Surface mount type products

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